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Dated: November 8, 2004 Signature: [Signature]
Michael R. Hull

Docket No.: 29936/39889
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Sang Kyun Park

Application No.: 10/749,022

Confirmation No.: 9225

Filed: December 30, 2003

Art Unit: 2812

For: METHOD OF FORMING COPPER WIRING IN SEMICONDUCTOR DEVICE

Examiner: Lynn Ann Gurley

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the office action mailed on August 6, 2004, please amend the above-identified patent application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 9 of this paper.

Remarks/Arguments in support of the allowability of this application begin on page 14 of this paper.